



Product Change Notification

Change Notification #: 118969-00
Change Title: Select Intel® Wireless-AC 9462,
Intel® Wireless-AC 9461
PCN 118969-00, Product Design, Label
Label and product design update
Date of Publication: March 14, 2022

Key Characteristics of the Change:

Product Design, Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material	March 26, 2022
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










Description of Change to the Customer:

The Intel® Wireless-AC9461 and the Intel® Wireless-AC9462 1216 SKUs listed in the products affected table below will undergo the following changes.

1. While updating the HW configuration bitmap in the new OTP, an additional bit was mistakenly configured which impacts the Wi-Fi boot sequence for the Intel® Wireless-AC9461 and the Intel® Wireless-AC9462 on Quasar-based platforms only. Update OTP back to previous version.
2. Product TA# dash up.

Product code	TA Before	TA After
9461.D2WG.NV	J80478-005	J80478-006

 9461.D2WG.NV	R/ID: XXXXXXXXXXXX	QTY: XXXX
MM #: XXXXXX		
TA: XXXXXX-XXX	HP P/N: XXXXXX-XXX	REV XX
		
T P/N: GTTTTTTTTTTT	XXXX-XXXXXXXXXXXXXX	
		
L P/N: XXXXXXXXXXXX	D P/N: PPPPPP	REV AXX
		

9461.D2WG.NV  VERSION #: XXXXXX-XXX  MADE IN XXXX WITH PARTIAL FOREIGN CONTENT CARTON #: VXXXXXXXXX 	 MM #: XXXXXX  PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVVYMDRSS 	QTY: XXXX   1 88334 00140 2  9 310779 300005	Intel® Wireless-AC 9461 (Model: 9461D2W)		          			
			PKG ID (3S) VVVVMMMMDDDD###PPPPPP1000 			T P/N: GTTTTTTTTTTT		
			D P/N: PPPPPP 	REV AXX 		HP P/N: XXXXXX-XXX 	REV: XX 	PACKAGE WEIGHT: XX LBS
			Vendor ID Loc Id VVVVVLLLLL	Mfg Id MMMMM		L P/N: XXXXXXXXXXXX 		EC#: XXXXXXXX

Product code	TA Before	TA After
9462.D2WG.NV	J88403-005	J88403-006

 9462.D2WG.NV	R/ID: XXXXXXXXXXXX	QTY: XXXX
MM #: XXXXXX		
TA: XXXXXX-XXX	HP P/N: XXXXXX-XXX	REV XX
		
T P/N: GTTTTTTTTTT	XXXX-XXXXXXXXXXXX	
		
L P/N: XXXXXXXXXXXX	D P/N: PPPPPP	REV AX
		

9462.D2WG.NV		QTY: XXXX	Intel® Dual Band Wireless-AC 9462 (Model: 9462D2W)		  <table border="1" data-bbox="1621 776 1759 831"> <tr><td>AT</td><td>BE</td><td>BG</td><td>CH</td><td>CY</td><td>CZ</td><td>DE</td></tr> <tr><td>DK</td><td>EE</td><td>EL</td><td>ES</td><td>FI</td><td>FR</td><td>HR</td></tr> <tr><td>HU</td><td>IE</td><td>IS</td><td>IT</td><td>LI</td><td>LT</td><td>LU</td></tr> <tr><td>LV</td><td>MT</td><td>NL</td><td>PL</td><td>PT</td><td>RO</td><td>SE</td></tr> <tr><td>SI</td><td>SK</td><td>TR</td><td>UK</td><td></td><td></td><td></td></tr> </table> <p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p>	AT	BE	BG	CH	CY	CZ	DE	DK	EE	EL	ES	FI	FR	HR	HU	IE	IS	IT	LI	LT	LU	LV	MT	NL	PL	PT	RO	SE	SI	SK	TR	UK			
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DK	EE	EL	ES	FI	FR	HR																																		
HU	IE	IS	IT	LI	LT	LU																																		
LV	MT	NL	PL	PT	RO	SE																																		
SI	SK	TR	UK																																					
	MM #: XXXXXX		PKG ID (3S) VVVVMMMMDDDD###PPPPPP1000	T P/N: GTTTTTTTTTT																																				
VERSION #: XXXXXX-XXX			D P/N: PPPPPP	REV AX	HP P/N: XXXXX-XXX	REV: XX	PACKAGE WEIGHT: 3.3 LBS																																	
MADE IN XXXXX WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXX	PACK DATE: DD MMM YY PACKED BY: XXXXXX	1 88334 00140 2	Vendor ID Loc Id VVVVVLLLLL	Mfg Id MMMMM	L P/N: XXXXXXXXXXXX	EC: XXXXXXXX																																		
	BATCH #: CCVVYMDRSS		9 310779 300005		    <p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p>																																			

Customer Impact of Change and Recommended Action:

The label and the hardware configuration bitmap change to the products do not affect functionality. Intel anticipates no impact to customers.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Post Change TA
Intel® Wireless-AC 9461, 1216, 1x1 AC+BT, No vPro®, Single Antenna	9461.D2WG.NV	958853	J80478-005	J80478-006
Intel® Wireless-AC 9462, 1216, 1x1 AC+BT, No vPro®, Diversity Antenna	9462.D2WG.NV	958854	J88403-005	J88403-006

PCN Revision History:

Date of Revision:

March 14, 2022

Revision Number:

00

Reason:

Originally Published PCN



Product Change Notification

118969-00

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The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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